74AHC257-Q100; 74AHCT257-Q100 Quad 2-input multiplexer; 3-state

Rev. 1 — 22 July 2013

Product data sheet

1. **General description**

The 74AHC257-Q100; 74AHCT257-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC257-Q100; 74AHCT257-Q100 has four identical 2-input multiplexers with 3-state outputs. They select 4 bits of data from two sources and a common data select input (S) controls them. The data inputs from source 0 (110 to 410), are selected when input S is LOW. The data inputs from source 1 (111 to 411) are selected when input S is HIGH. Data appears at the outputs (1Y to 4Y) in true (non-inverting) form from the selected inputs. The 74AHC257-Q100; 74AHCT257-Q100 is the logic implementation of a 4-pole 2-position switch. The logic levels applied to input S determine the position of the switch. The outputs are forced to a high-impedance OFF-state when \overline{OE} is HIGH.

The logic equations for the outputs are:

$$1Y = \overline{OE} \times (111 \times S + 110 \times \overline{S})$$

$$2Y = \overline{OE} \times (211 \times S + 210 \times \overline{S})$$

$$3Y = \overline{OE} \times (311 \times S + 310 \times \overline{S})$$

$$4Y = \overline{OE} \times (411 \times S + 410 \times \overline{S})$$

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Non-inverting data path
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - For 74AHC257-Q100: CMOS level
 - For 74AHCT257-Q100: TTL level

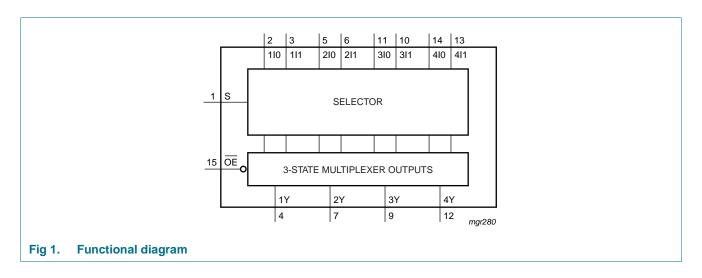


- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

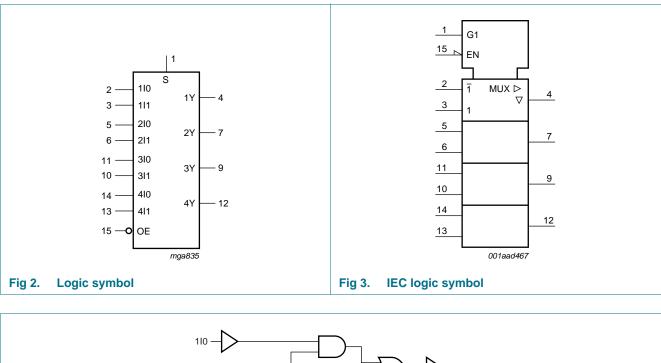
3. Ordering information

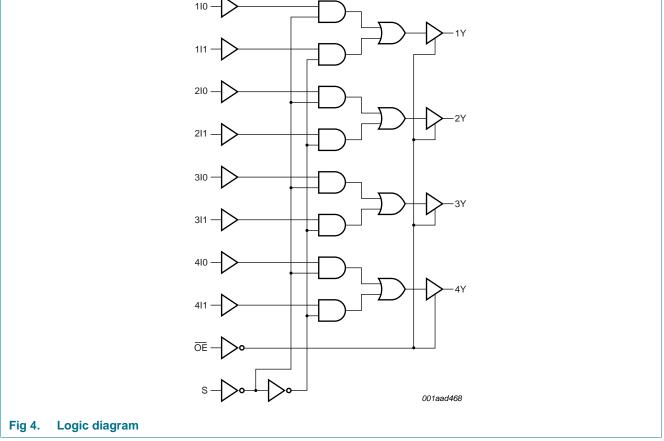
Table 1. Ordering i	nformation			
Type number	Package			
	Temperature range	Name	Description	Version
74AHC257-Q100				
74AHC257D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74AHC257PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74AHCT257-Q100				
74AHCT257D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74AHCT257PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

4. Functional diagram



Quad 2-input multiplexer; 3-state

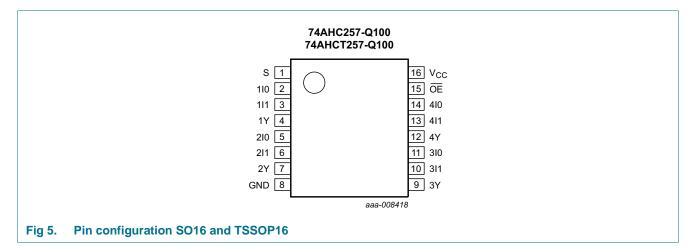




Quad 2-input multiplexer; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

SymbolPinDescriptionS1common data select input1102data input from source 01113data input from source 11Y4multiplexer output2105data input from source 02116data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output31011data input from source 131110data input from source 14Y12multiplexer output4Y12multiplexer output4I113data input from source 14I014data input from source 14I015output from source 0Vcc16supply voltage	Table 2.	Pin description	
1102data input from source 01113data input from source 11Y4multiplexer output2105data input from source 02116data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output31011data input from source 131011data input from source 04Y12multiplexer output41014data input from source 15005060070031110031211313031413315031614317153181531915310143101431115311153121531315314153151531531515316317153183193193103103103131031310313103131031311313123131331314313153131531316313173131831 <th>Symbol</th> <th>Pin</th> <th>Description</th>	Symbol	Pin	Description
1113data input from source 11Y4multiplexer output2I05data input from source 02I16data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output3I110data input from source 13I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	S	1	common data select input
1Y4multiplexer output2I05data input from source 02I16data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output3I110data input from source 13I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	110	2	data input from source 0
2105data input from source 02116data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output3I110data input from source 13I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	111	3	data input from source 1
2116data input from source 12Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output31110data input from source 131011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	1Y	4	multiplexer output
2Y7multiplexer outputGND8ground (0 V)3Y9multiplexer output3I110data input from source 13I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	210	5	data input from source 0
GND8ground (0 V)3Y9multiplexer output3l110data input from source 13l011data input from source 04Y12multiplexer output4l113data input from source 14l014data input from source 0OE15output enable input (active LOW)	211	6	data input from source 1
3Y9multiplexer output3I110data input from source 13I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	2Y	7	multiplexer output
31110data input from source 131011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	GND	8	ground (0 V)
3I011data input from source 04Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	3Y	9	multiplexer output
4Y12multiplexer output4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	311	10	data input from source 1
4I113data input from source 14I014data input from source 0OE15output enable input (active LOW)	310	11	data input from source 0
41014data input from source 0OE15output enable input (active LOW)	4Y	12	multiplexer output
OE 15 output enable input (active LOW)	411	13	data input from source 1
	410	14	data input from source 0
V _{CC} 16 supply voltage	OE	15	output enable input (active LOW)
	V _{CC}	16	supply voltage

Quad 2-input multiplexer; 3-state

6. Functional description

Table 3.	Function table ^[1]				
Control		Input		Output	
OE	S	nl0	nl1	nY	
Н	Х	Х	Х	Z	
L	Н	Х	L	L	
		Х	Н	Н	
	L	L	Х	L	
		Н	Х	Н	

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	<u>[1]</u> –20	-	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> –20	+20	mA
lo	output current	V_{O} = -0.5 V to (V _{CC} + 0.5 V)	-25	+25	mA
I _{CC}	supply current		-	+75	mA
I _{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.

For TSSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

8. Recommended operating conditions

Table 5.	Operating conditions					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74AHC25	7-Q100					
V _{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 3.0 V to 3.6 V	-	-	100	ns/V
		V_{CC} = 4.5 V to 5.5 V	-	-	20	ns/V
74AHCT2	57-Q100					
V _{CC}	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 4.5 V to 5.5 V	-	-	20	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC2	57-Q100	'								
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{ОН}	HIGH-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	I_{O} = -50 μ A; V_{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_{O} = –50 $\mu\text{A};V_{CC}$ = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I_{O} = -50 μ A; V_{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		$I_0 = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V

Quad 2-input multiplexer; 3-state

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	-40 °C t	to +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
lı	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{OZ}	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	4.0	-	40	-	80	μA
CI	input capacitance	$V_{I} = V_{CC} \text{ or } GND$	-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF
74AHCT	257-Q100									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
VIL	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
lı	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
I _{OZ}	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μΑ
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	4.0	-	40	-	80	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V};$ other pins at V_{CC} or GND; $I_O = 0 \text{ A}; V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance	$V_{I} = V_{CC}$ or GND	-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Quad 2-input multiplexer; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see <u>Figure 8</u>.

Symbol	Parameter	Conditions			25 °C		−40 °C	to +85 °C	–40 °C	to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
74AHC2	57-Q100										
t _{pd}	propagation	nI0, nI1 to nY; see Figure 6	[2]								
	delay	V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	4.2	9.3	1.0	11.0	1.0	12.0	ns
		C _L = 50 pF		-	6.0	12.8	1.0	14.5	1.0	16.0	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	2.9	5.9	1.0	7.0	1.0	7.5	ns
		C _L = 50 pF		-	4.2	7.9	1.0	9.0	1.0	11.5	ns
		S to nY; see Figure 6	[2]								
		V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	5.2	11.0	1.0	13.0	1.0	14.0	ns
		C _L = 50 pF		-	7.4	14.5	1.0	16.5	1.0	18.5	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	3.5	6.8	1.0	8.0	1.0	8.5	ns
		C _L = 50 pF		-	5.0	8.8	1.0	10.0	1.0	12.5	ns
en	enable time	OE to nY; see Figure 7	[3]								
		V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	4.5	10.5	1.0	12.5	1.0	13.5	ns
		C _L = 50 pF		-	6.4	14.0	1.0	16.0	1.0	17.5	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	3.2	6.8	1.0	8.0	1.0	8.5	ns
		C _L = 50 pF		-	4.5	8.8	1.0	10.0	1.0	12.5	ns
dis	disable time	OE to nY; see Figure 7	[4]								
		V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	5.1	9.5	1.0	11.0	1.0	11.5	ns
		C _L = 50 pF		-	7.2	12.0	1.0	13.5	1.0	14.5	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	3.4	6.5	1.0	7.0	1.0	8.5	ns
		C _L = 50 pF		-	4.9	7.9	1.0	9.0	1.0	9.5	ns
C _{PD}	power	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	[5]								
	dissipation capacitance	4 outputs switching via input S		-	45	-	-	-	-	-	pF
		1 output switching via input I		-	15	-	-	-	-	-	pF

Quad 2-input multiplexer; 3-state

Symbol	Parameter	Conditions		25 °C	;	–40 °C	to +85 °C	-40 °C 1	to +125 °C	Unit
			Μ	in Typ <mark>(</mark>	l Max	Min	Max	Min	Max	-
74AHCT	257-Q100; V _C	_C = 4.5 V to 5.5 V								
t _{pd}	propagation	nI0, nI1 to nY; see Figure 6	[2]							
	delay	C _L = 15 pF		3.7	6.5	1.0	8.0	1.0	9.0	ns
		C _L = 50 pF		4.9	8.5	1.0	10.0	1.0	11.0	ns
		S to nY; see Figure 6	[2]							
		C _L = 15 pF		5.1	9.0	1.0	10.5	1.0	11.5	ns
		C _L = 50 pF		6.4	10.5	1.0	12.5	1.0	13.5	ns
t _{en}	enable time	OE to nY; see Figure 7	[3]							
		C _L = 15 pF		3.9	8.0	1.0	9.0	1.0	10.0	ns
		C _L = 50 pF		5.1	10.0	1.0	11.0	1.0	12.0	ns
t _{dis}	disable time	OE to nY; see Figure 7	<u>[4]</u>							
		C _L = 15 pF		4.5	7.5	1.0	8.0	1.0	8.5	ns
		C _L = 50 pF		6.5	9.5	1.0	10.5	1.0	11.5	ns
C _{PD}	power	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	[5]							
	dissipation capacitance	4 outputs switching via input S		51	-	-	-	-	-	pF
		1 output switching via input I		15	-	-	-	-	-	pF

Table 7. Dynamic characteristics ... continued

[1] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3$ V and $V_{CC} = 5.0$ V).

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] t_{en} is the same as t_{PZL} and t_{PZH} .

[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Vм

VM

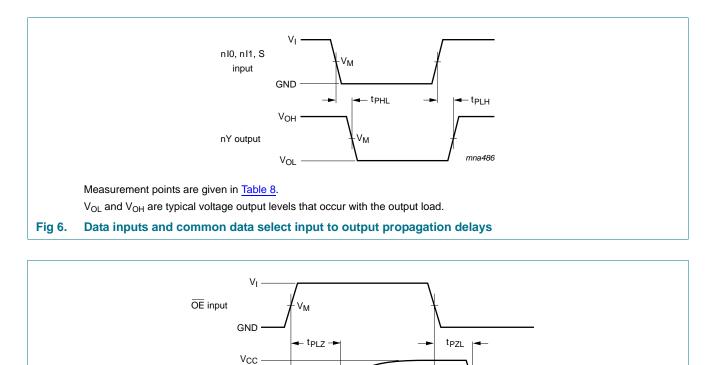
outputs

enabled mna813

🖛 t_{PZH} →

outputs disabled Quad 2-input multiplexer; 3-state

11. Waveforms



Measurement points are given in Table 8.

Qn output LOW-to-OFF

OFF-to-LOW

Qn output HIGH-to-OFF

OFF-to-HIGH

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Vol

VOH

GND

outputs enabled

Fig 7. Enable and disable times

Table 8.Measurement points

Туре	Input	Output		
	V _M	V _M	V _X	V _Y
74AHC257-Q100	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V
74AHCT257-Q100	1.5 V	$0.5\times V_{CC}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V

74AHC_AHCT257_Q100

NXP Semiconductors

74AHC257-Q100; 74AHCT257-Q100

Quad 2-input multiplexer; 3-state

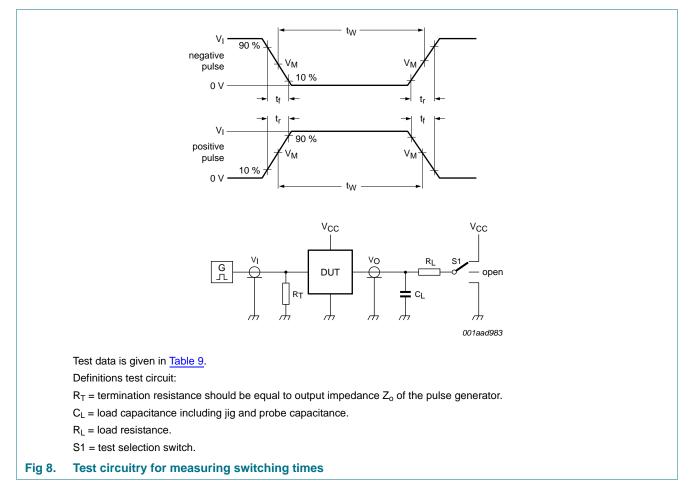


Table 9. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74AHC257-Q100	V _{CC}	\leq 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74AHCT257-Q100	3.0 V	\leq 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

Quad 2-input multiplexer; 3-state

12. Package outline

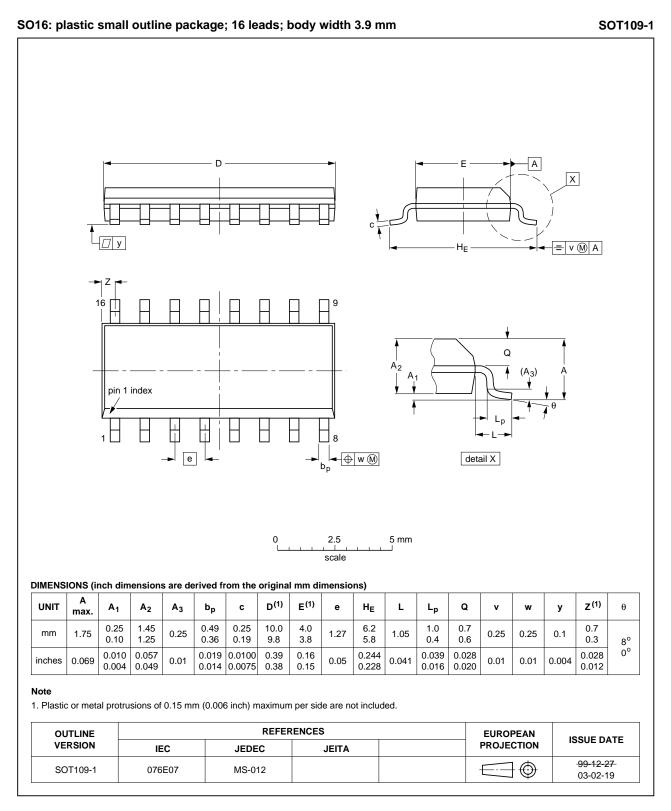


Fig 9. Package outline SOT109-1 (SO16)

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Quad 2-input multiplexer; 3-state

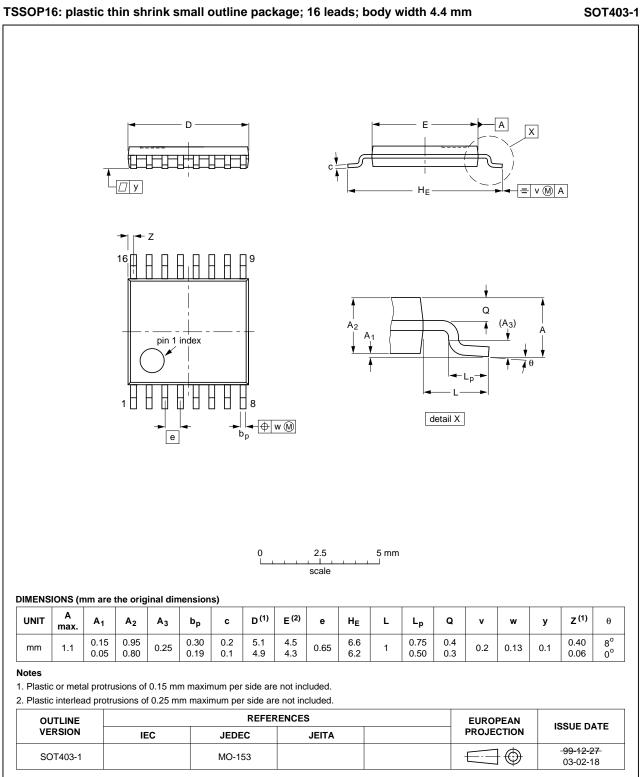


Fig 10. Package outline SOT403-1 (TSSOP16)

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Quad 2-input multiplexer; 3-state

13. Abbreviations

Acronym CDM CMOS ESD	Description Charged Device Model
CMOS	
	Complementary Metal Ovide Semiconductor
ESD	Complementary Metal-Oxide Semiconductor
	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
MIL	Military
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT257_Q100 v.1	20130722	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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